



Koruza high speed flex board

CONTENTS:

PAGE1 - CONTENTS

PAGE2 - SFP CONNECTORS

REVISION HISTORY:

v0.2 - 09.03.2017.

v0.3 - 04.05.2017.

DESIGN CONSIDERATIONS

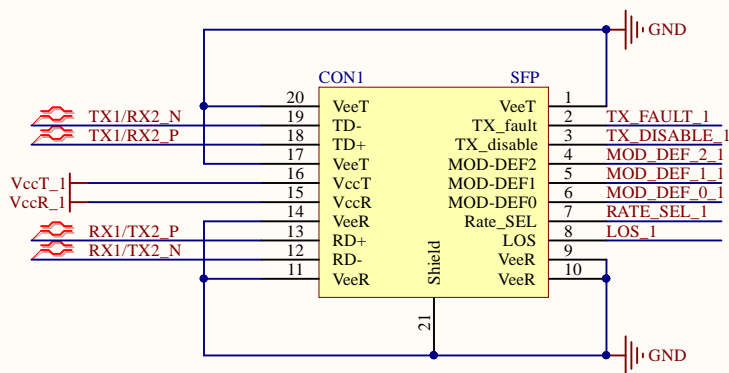
DESIGN NOTE:
Example text for informational
design notes.

DESIGN NOTE:
Example text for critical
design notes.

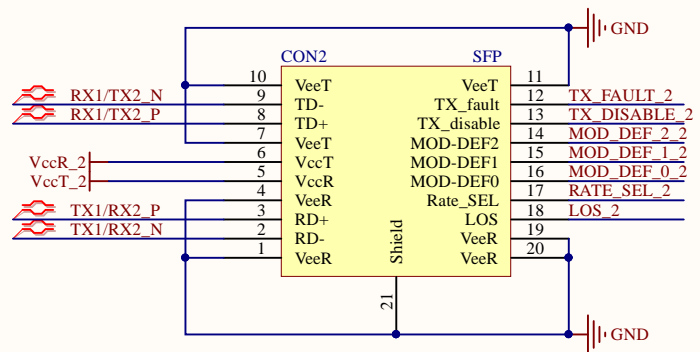
LAYOUT NOTE:
Example text for critical
layout guidelines.

Koruza		www.koruza.net	
Title: koruza-hs-flex-PCB.PrjPcb			
Page Contents: PAGE1-CONTENTS.SchDoc			
Size:	DWG NO		Revision: v0.3
Date: *	Sheet 1 of 2		

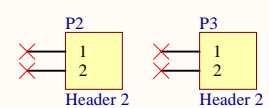
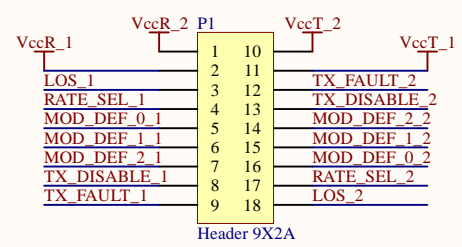
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SFP IN - 1



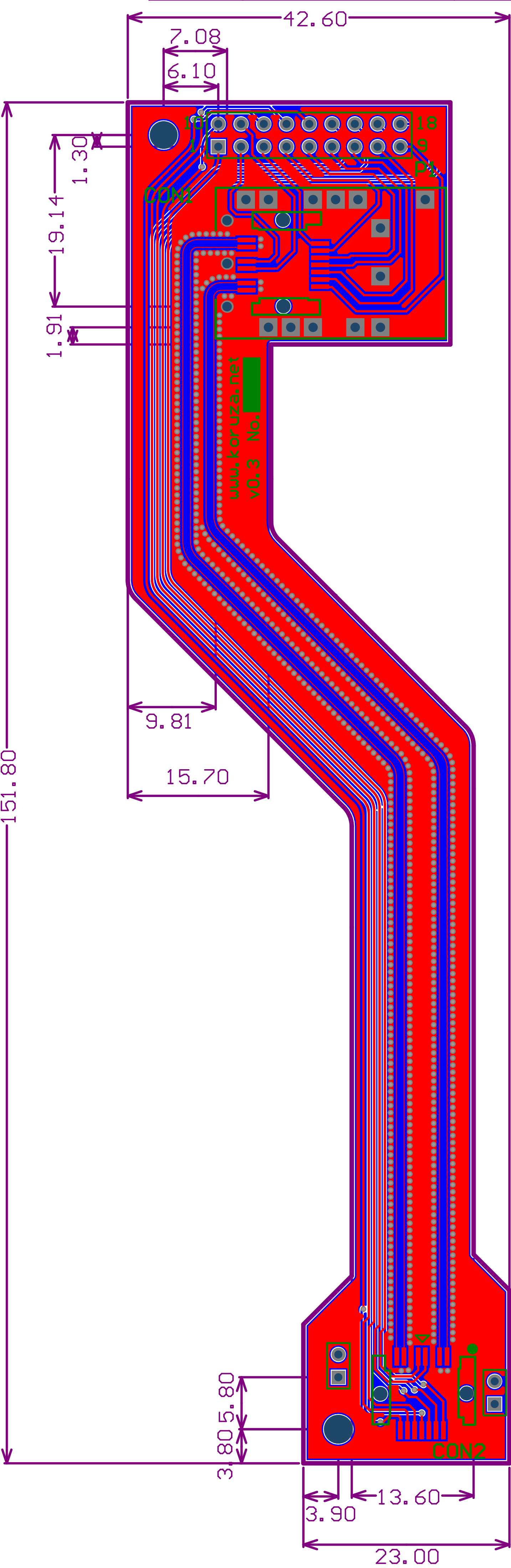
REVERCE SFP
SFP OUT - 2



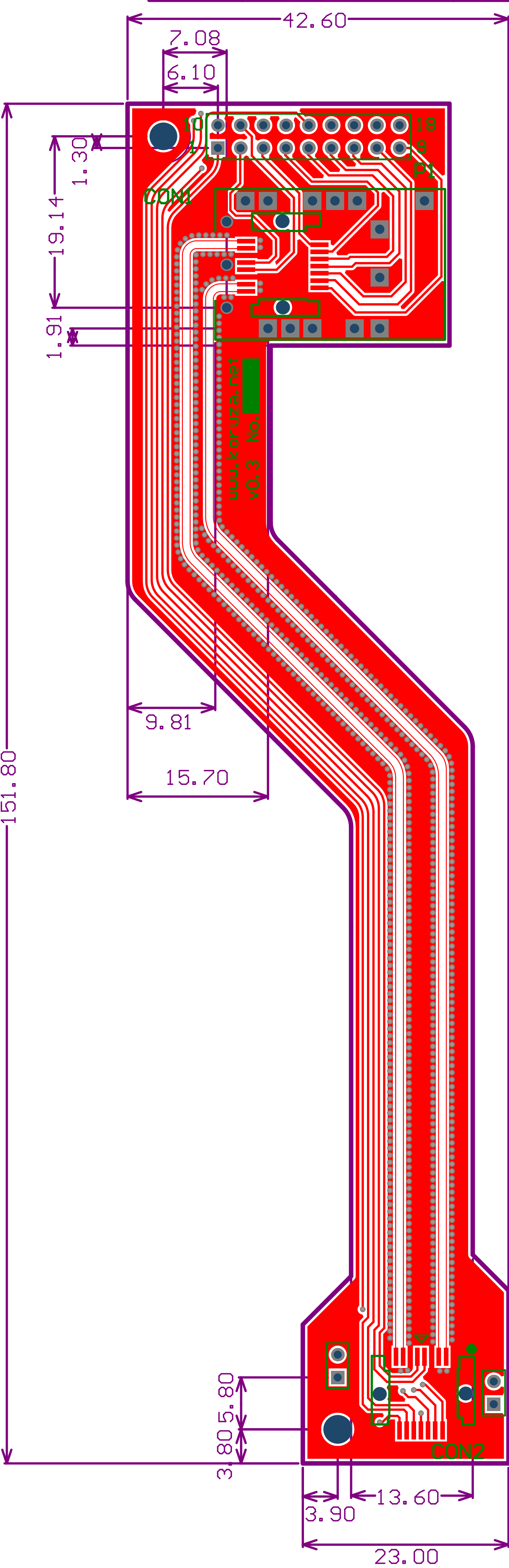
FLEX TO RIGID



Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	0.50mil	3.5	
3	Top Layer	Copper	0.70mil		
4	Dielectric 1	FR-4	2.00mil	3.2	
5	Bottom Layer	Copper	0.70mil		
6	Bottom Solder	Solder Resist	0.50mil	3.5	
7	Bottom Overlay				



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